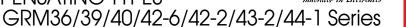
SURFACE MOUNT MONOLITHIC CHIP CAPACITORS COG AND TEMPERATURE COMPENSATING TYPES

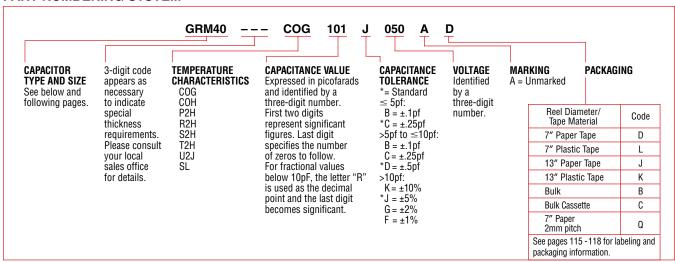




FEATURES

- Miniature size
- No Polarity
- Nickel Barrier Termination Standard highly resistant to metal migration
- Uniform dimensions and configuration
- Suitable for reflow soldering
- GRM39, 40 and 42-6 suitable for wave soldering
- Minimum series inductance
- Tape and Reel Packaging
- Bulk Case Packaging available for GRM40 and smaller
- Wide selection of capacitance values and voltages
- Largest production capacity and volume in the world

PART NUMBERING SYSTEM

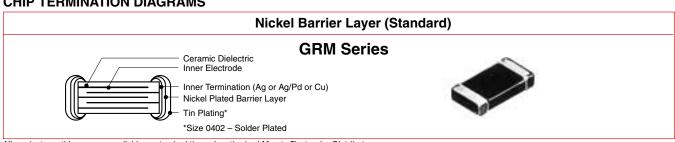


CHIP DIMENSIONS

Dimensions: mm	Size	EIA Code	L Length	W Width	T Thickness	e (min.) Termination	g (min.) Insulation
	GRM36	0402	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	0.15 ~ 0.3	0.4
	GRM39*	0603	1.6 ± 0.1	0.8 ± 0.1	0.8 ± 0.1	0.2 ~ 0.5	0.5
				$ \begin{array}{c} 0.6 \pm 0.1 \\ 1.25 \pm 0.1 \\ \end{array} $	0.6 ± 0.1		
→ e g e -	GRM40	//40 0805 2.0 ±	2.0 ± 0.1		0.85 ± 0.1	0.2 ~ 0.7	0.7
					1.25 ± 0.1		
			3.2 ± 0.15	1.6 ± 0.15	0.85 ± 0.1		
	GRM42-6	1206	3.2 ± 0.13	1.0 ± 0.13	1.15 ± 0.1	0.3 ~ 0.8	1.5
			3.2 ± 0.2	1.6 ± 0.2	1.6 ± 0.2	0.3 ~ 0.8	
<u> </u>					1.15 ± 0.1	1 35 + 0 15	1.0
l← L W	GRM42-2	1210	3.2 ± 0.3	2.5 ± 0.2	1.35 ± 0.15		
L W	└ VV GRIVI42-2	1210	3.2 ± 0.3	2.5 ± 0.2	1.8 ± 0.2 0.3 min.	1.0	
					2.5 ± 0.2		
	GRM43-2	1812	4.5 ± 0.4	3.2 ± 0.3	2.0 max.	0.3 min.	2.0
	GRM44-1	2220	5.7 ± 0.4	5.0 ± 0.4	2.0 max.	0.3 min.	2.0

^{*}Bulk case packaging is L = 1.6 \pm 0.07, W, T = 0.8 \pm 0.07.

CHIP TERMINATION DIAGRAMS



All products on this page are available as standard through authorized Murata Electronics Distributors.

SURFACE MOUNT MONOLITHIC CHIP CAPACITORS COG AND TEMPERATURE COMPENSATING TYPES — SPECIFICATION GRM36/39/40/42-6/42-2/43-2/44-1 Series



GENERAL

Temperature Coefficient	Temperature Range
COG = 0 ± 30 ppm*	-55° to +125°C
$COH = 0 \pm 60 \text{ ppm}$	-55° to +125°C
$P2H = N150 \pm 60 ppm$	-55° to +85°C
$R2H = N220 \pm 60 ppm$	-55° to +85°C
$S2H = N330 \pm 60 ppm$	-55° to +85°C
$T2H = N470 \pm 60 \text{ ppm}$	−55° to +85°C
U2J = N750 ± 120 ppm	−55° to +85°C
SL = N1000 to P350	−55° to +85°C
*TC Tolerance for COG Refer to EIA-RS198E for other limitations	

ELECTRICAL

TEST			
Capacitance & Q (Frequency & Voltage):	≤1000pF 1MHz ± 100Hz @ 1.0 ± .2 Vrms >1000pF 1kHz ± 100Hz @ 1.0 ± .2 Vrms		
Q Limits	≤30pF: 400 + (20xC (pF)) >30pF: 1000 minimum		
Insulation Resistance (I.R.)	100,000 megohms or 1000 megohms – mfd (whichever is less) with rated voltage applied for 2 minutes max with 50mA limiting current		
Dielectric Strength (Flash)	250% of rated voltage for 5 seconds with series resistor limiting charging current to 50mA max.; 200% for 500V		
Aging Negligible			

MECHANICAL

TEST	TEST METHOD	POST TEST LIMITS
Terminal Adhesion	Glass Epoxy Board	≤0603 1.0 lbs. ≥0805 2.2 lbs. No evidence of termination peeling
Deflection	Capacitor R340 Load Deflection Unit: mm 45 45 Unit: mm Unit: mm Deflection Supporter	1 mm deflection (Glass epoxy board) No mechanical damage Cap., DF, IR meet initial limits
Solderability	MIL-STD-202 Method 208F	Contact factory for test limits

ENVIRONMENTAL

TEST	TEST METHOD	POST TEST LIMITS		
Thermal Shock (Air to Air)	MIL-STD-202, Method 107, Condition A Post thermal Shock measurement shall be taken after 24 hours stabilization.	Appearance: No visual damage ΔC : = $\pm 2.0\%$ or ± 0.5 pF (whichever is greater) Q: >30 pF = $1,000$ min., ≤ 30 pF = $400 + [20 \times C(pF)]$ I.R.: = $100,000$ M Ω min. or $1,000$ M Ω • μ F (whichever is less)		
Humidity, Steady State Maintain the capacitor at $40 \pm 2^{\circ}$ C and 90 to 95% humidity for 500 ± 12 hours. Remove and let sit for 24 ± 2 hours at room temperature, then measure. Appearance: No defects Capacitance: Within ±5% or ±.0.5pF (whichever is Q/D.F.: 30pF and over: Q≥350; 10pf to 30pf: Q≥27 10pf and below: Q≥200±10C I.R.: 1,000MΩ or 50MΩ F (whichever is less) C: Nominal Capacitance (pF)				
Humidity Load	Apply the rated voltage at $40 \pm 2^{\circ}\text{C}$ and 90 to 95% humidity for 500 ± 12 hours. Remove and let sit for 24 ± 2 hours at room temperature, then measure. The charge/discharge current is less than 50mA.	Appearance: No defects Capacitance: Within ±7.5% or ±.0.75pF (whichever is greater) Q/D.F.: 30pF and over: Q≥200; 30pf and below: Q≥100±10/3C I.R.: 500MΩ or 25MΩ F (whichever is less) C: Nominal Capacitance (pF)		
Life Test	Apply 200% of rated voltage for 1000 ± 12 hours at maximum operating temperature; 150% for 500V. Upon completion of above test wait 24 hours prior to performing post testing.	Appearance: No defects Capacitance: $\pm 3\%$ or $\pm .3$ pF (whichever is greater) Q: >30 pF = 500 min., ≤ 30 pF = $200 + [10 \times C(pF)]$ I.R.: $1,000$ M Ω or 50 M Ω F (whichever is less) Flash: 250% rated voltage		

STORAGE LIFE

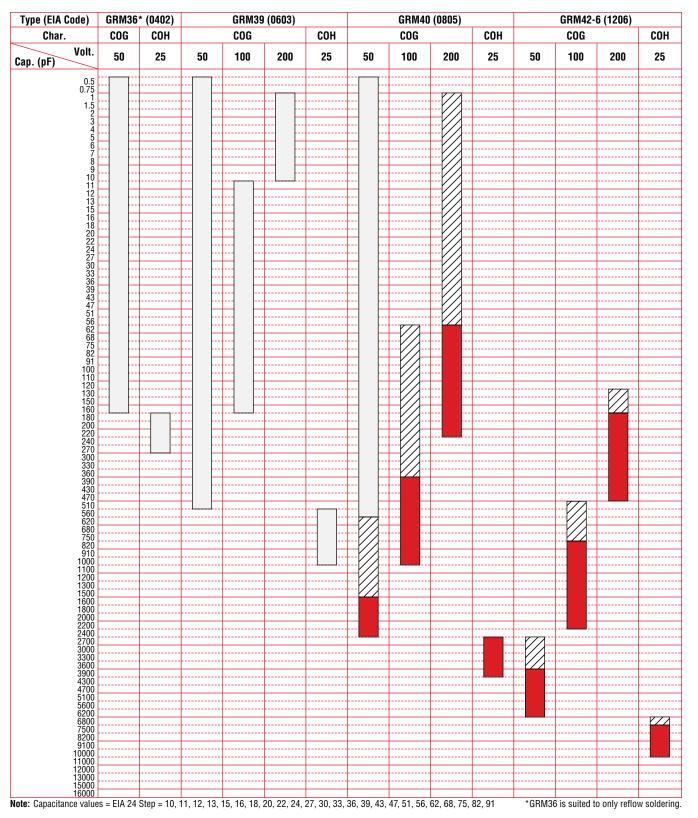
Chip component terminations should generally be protected from moisture. In addition, they should also be protected from materials containing chlorine, sulfur compounds or any harmful gases that could cause degradation of the solder.

- 1. All chip components, including tape and reel, should be kept in an area where the temperature is between 5°C and 40°C and where the humidity is 20% to 70%.
- 2. The chip components should be used within six months.
- 3. The solderability of the chip components should be rechecked in the event that they are not used in six months.
- 4. Peel strength and shelf life of tape are guaranteed for 1 year when stored under afore said conditions.

SURFACE MOUNT MONOLITHIC CHIP CAPACITORS COG/COH TYPE-25V/50V/100V/200V



GRM36/39/40/42-6 Series



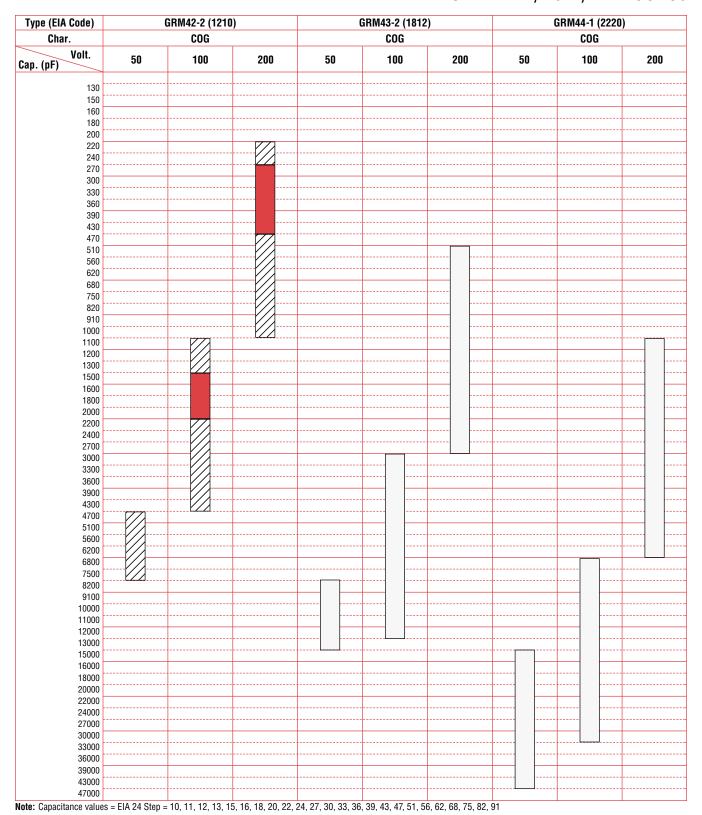
THICKNESS AND PACKAGING TYPES/QUANTITY

Туре	Thickness: T (mm)	Bulk (pcs./bag)	Taping (pcs./ф178mm reel) ¹	Bulk Case (pcs./case)	Туре	Thickness: T (mm)	Bulk (pcs./bag)	Taping (pcs./ф178mm reel)¹	Bulk Case (pcs./case)
GRM36	: 0.5 ± 0.05	1000	10000	50000	GRM42-6	: 0.85 ± 0.1	1000	4000	_
GRM39	$\boxed{}$: 0.8 ± 0.1 ²	1000	4000	15000	GKIVI4Z-0	: 1.15 ± 0.1	1000	3000	_
	: 0.6 ± 0.1	1000	4000	10000					
GRM40	: 0.85 ± 0.1	1000	4000	_					
	: 1.25 ± 0.1	1000	3000	5000	¹ф330mm	reel is available on requ	est. ² Bulk cas	e packaging is $T = 0.8 \pm 0.0$	17.

SURFACE MOUNT MONOLITHIC CHIP CAPACITORS COG TYPE-50V/100V/200V



GRM42-2/43-2/44-1 Series



THICKNESS AND PACKAGING TYPES/QUANTITY

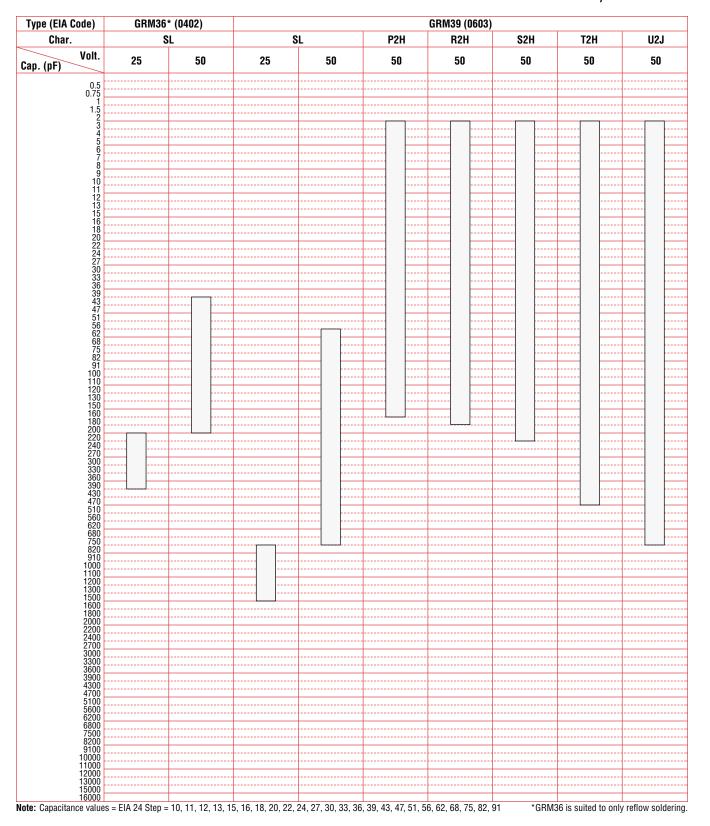
Туре	Thickness: T (mm)	Bulk (pcs./bag)	Taping (pcs./φ178mm reel)*		
GRM42-2	: 1.35 ± 0.15	1000	2000		
GRM43-2	: 2.0 max.	1000	1000		
GRM44-1	: 2.0 max.	1000	1000		

^{*\$\}phi330mm reel is available on request.

SURFACE MOUNT MONOLITHIC CHIP CAPACITORS TEMPERATURE COMPENSATING TYPE-25V/50V



GRM36/39 Series



THICKNESS AND PACKAGING TYPES/QUANTITY

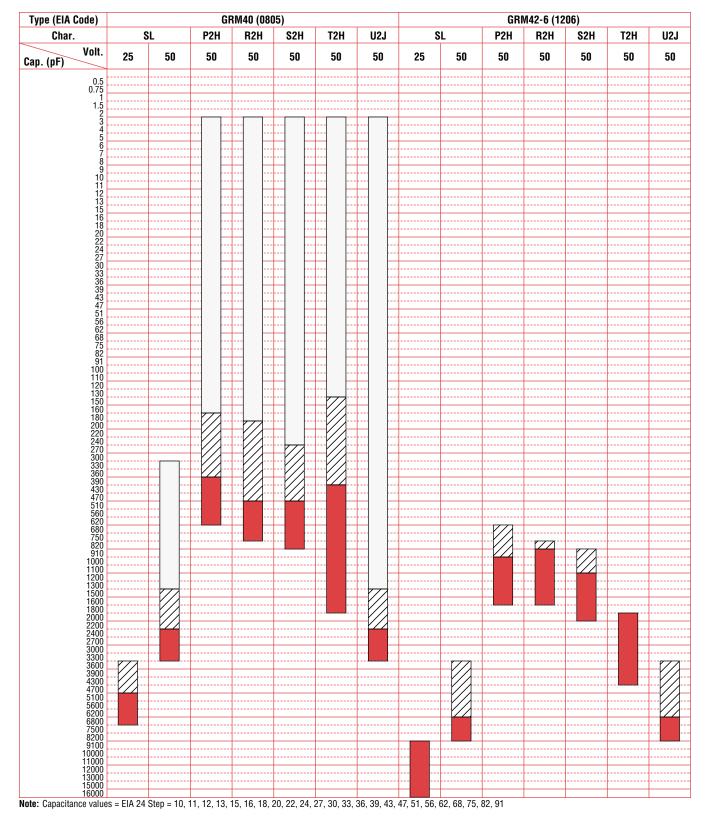
111101111200711121711011111111111111111								
Туре	Thickness: T (mm)	Bulk (pcs./bag)	Taping (pcs./ф178mm reel)¹	Bulk Case (pcs./case)				
GRM36	: 0.5 ± 0.05	1000	10000	50000				
GRM39	: 0.8 ± 0.1 ²	1000	4000	15000				

 $^{^{1}}$ ϕ 330mm reel is available on request. 2 Bulk case packaging is T = 0.8 ± 0.07.

SURFACE MOUNT MONOLITHIC CHIP CAPACITORS TEMPERATURE COMPENSATING TYPE-25V/50V



GRM40/42-6 Series



THICKNESS AND PACKAGING TYPES/QUANTITY

Type	Thickness: T (mm)	Bulk (pcs./bag)	Taping (pcs./ф178mm reel)*	Bulk Case (pcs./case)	Туре	Thickness: T (mm)	Bulk (pcs./bag)	Taping (pcs./ф178mm reel)*	Bulk Case (pcs./case)
	: 0.6 ± 0.1	1000	4000	10000	GRM42-6	: 0.85 ± 0.1	1000	4000	_
GRM40	: 0.85 ± 0.1	1000	4000	_	UNIVI42-0	: 1.15 ± 0.1	1000	3000	_
	: 1.25 ± 0.1	1000	3000	5000	*φ330mm reel is available on request.				